

SCHOTTKY -BARRIER RECTIFIER DIODES



High-efficiency schottky-barrier rectifier diodes in DO-4 metal envelopes, featuring low forward voltage drop, low capacitance, absence of stored charge and high temperature stability. They are intended for use in low output voltage switched-mode power supplies and high-frequency circuits in general, where both low conduction losses and zero switching losses are important. They can also withstand reverse voltage transients. The series consists of normal polarity (cathode to stud) types. A version with guaranteed reverse surge capability, BYV20-40A, is also available.

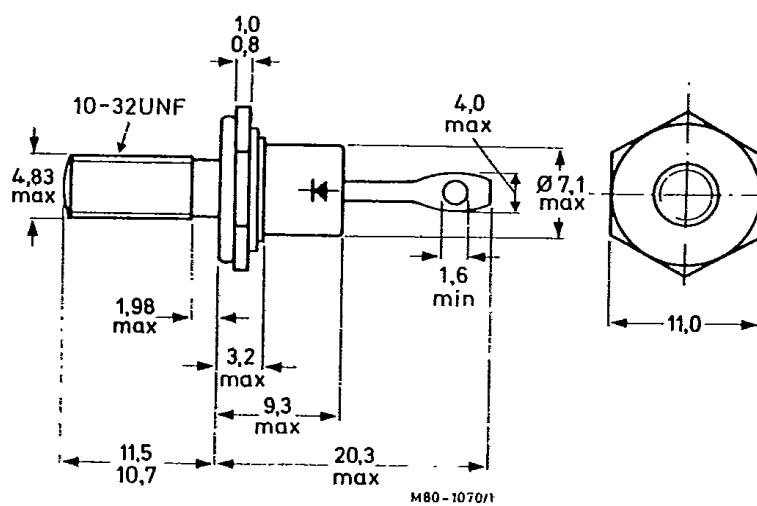
QUICK REFERENCE DATA

	V _{RRM}	BYV20-30	35	40(A)	45	
Repetitive peak reverse voltage		max. 30	35	40	45	V
Average forward current	I _{F(AV)}	max.		15		A
Forward voltage	V _F	<		0.6		V
Junction temperature	T _j	max.		150		°C

MECHANICAL DATA

Dimensions in mm

Fig.1 DO-4 with 10-32 UNF stud ($\phi 4.83$ mm) as standard.
Metric M5 stud ($\phi 5$ mm) is available on request, eg. BYV20-30M.



Net mass: 6 g

Diameter of clearance hole: 5.2 mm

Accessories supplied on request:

56295a (mica washer); 56295b (PTFE ring);
56295c (insulating bush).

Supplied with device: 1 nut, 1 lock washer,
Torque on nut:

min. 0.9 Nm (9 kg cm),
max. 1.7 Nm (17 kg cm).

Nut dimensions across the flats:
10-32 UNF, 9.5 mm; M5, 8.0 mm.

Products approved to CECC 50 009-033 available on request.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134).

Voltages		BYV20-30	35	40(A)	45	
Non-repetitive peak reverse voltage	V_{RSM}	max.	36	42	48	54
Repetitive peak reverse voltage (note 1)	V_{RRM}	max.	30	35	40	45
Crest working reverse voltage	V_{RWM}	max.	30	35	40	45
Continuous reverse voltage	V_R	max.	30	35	40	45
→ Currents						
Average forward current square wave; $\delta = 0.5$; up to $T_{mb} = 121^\circ\text{C}$ (note 2)	$I_{F(AV)}$	max.		15		- A
sinusoidal; up to $T_{mb} = 124^\circ\text{C}$ (note 2)	$I_{F(AV)}$	max.		12.5		A
R.M.S. forward current	$I_{F(RMS)}$	max.		21		A
Repetitive peak forward current $t_p = 20 \mu\text{s}; \delta = 0.02$	I_{FRM}	max.		260		A
Non-repetitive peak forward current half sine-wave; $T_j = 125^\circ\text{C}$ prior to surge; with reapply V_{RWM} max; $t = 10 \text{ ms}$	I_{FSM}	max.		300		A
$t = 8.3 \text{ ms}$	I_{FSM}	max.		330		A
$I^2 t$ for fusing ($t = 10 \text{ ms}$)	$I^2 t$	max.		450		$\text{A}^2 \text{s}$
Reverse surge current (BYV20-40A only) $t_p = 100 \mu\text{s}$	I_{RSM}	max.		1.0		A
Temperatures						
Storage temperature	T_{stg}			-55 to +150		$^\circ\text{C}$
Junction temperature	T_j	max.		150		$^\circ\text{C}$

MOUNTING INSTRUCTIONS

The top connector should be neither bent nor twisted; it should be soldered into the circuit so that there is no strain on it.

During soldering, the heat conduction to the junction should be kept to a minimum.

Notes:

1. For $t_p = 200 \text{ ns}$ a 20% increase in V_{RRM} is allowed.
2. Assuming no reverse leakage current losses.

THERMAL RESISTANCE

From junction to mounting base	$R_{th\ j\text{-}mb}$	=	2.2	K/W
From mounting base to heatsink with heatsink compound	$R_{th\ mb\text{-}h}$	=	0.5	K/W
Transient thermal impedance; $t = 1\text{ ms}$	$Z_{th\ j\text{-}mb}$	=	0.85	K/W

CHARACTERISTICS

Forward voltage $I_F = 15\text{ A}; T_j = 100\text{ }^\circ\text{C}$	V_F	<	0.6	V*
$I_F = 40\text{ A}; T_j = 25\text{ }^\circ\text{C}$	V_F	<	1.0	V*
Rate of rise of reverse voltage $V_R = V_{RWMmax}$	$\frac{dV_R}{dt}$	<	1500	V/ μ s
Reverse current $V_R = V_{RWMmax}; T_j = 125\text{ }^\circ\text{C}$	I_R	<	70	mA
Capacitance at $f = 1\text{ MHz}$ $V_R = 5\text{ V}; T_j = 25\text{ to }125\text{ }^\circ\text{C}$	C_d	typ.	520	pF

*Measured under pulse conditions to avoid excessive dissipation.

SQUARE-WAVE OPERATION (Figs.3 and 4)

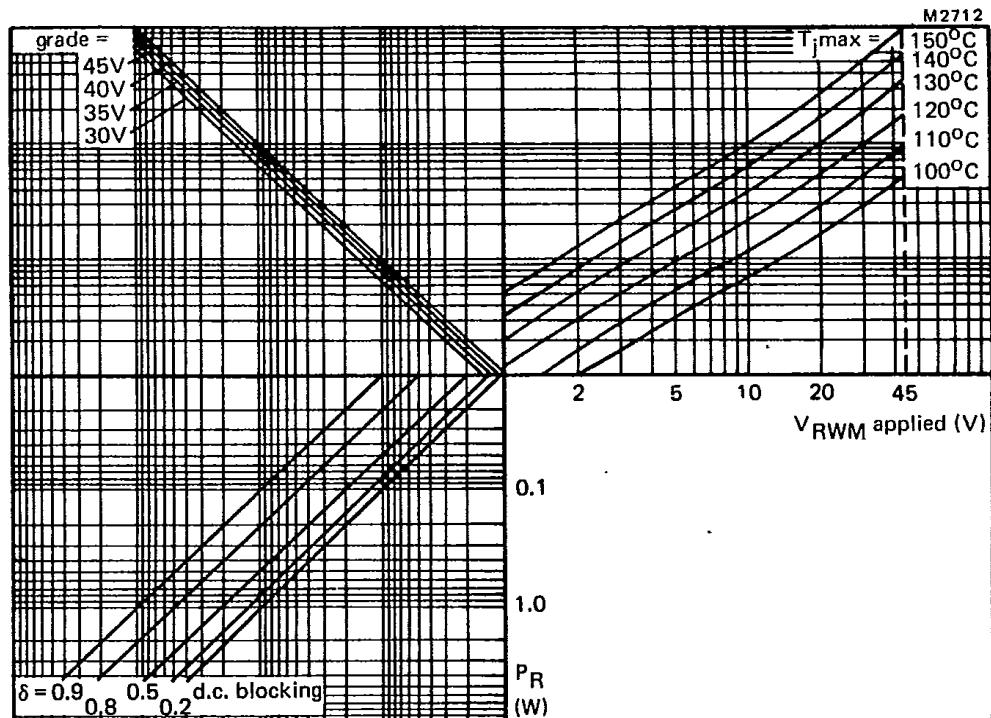
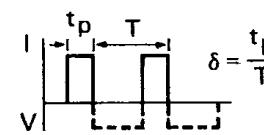
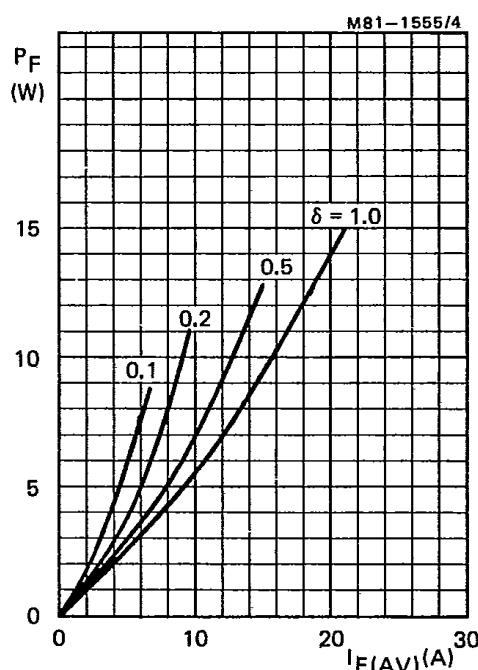


Fig.3 NOMOGRAM: for calculation of P_R (reverse leakage power dissipation) for a given T_j max., V_{RWM} applied, voltage grade and duty cycle.



$$I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$$

Fig.4.

SINE-WAVE OPERATION (Figs.5 and 6)

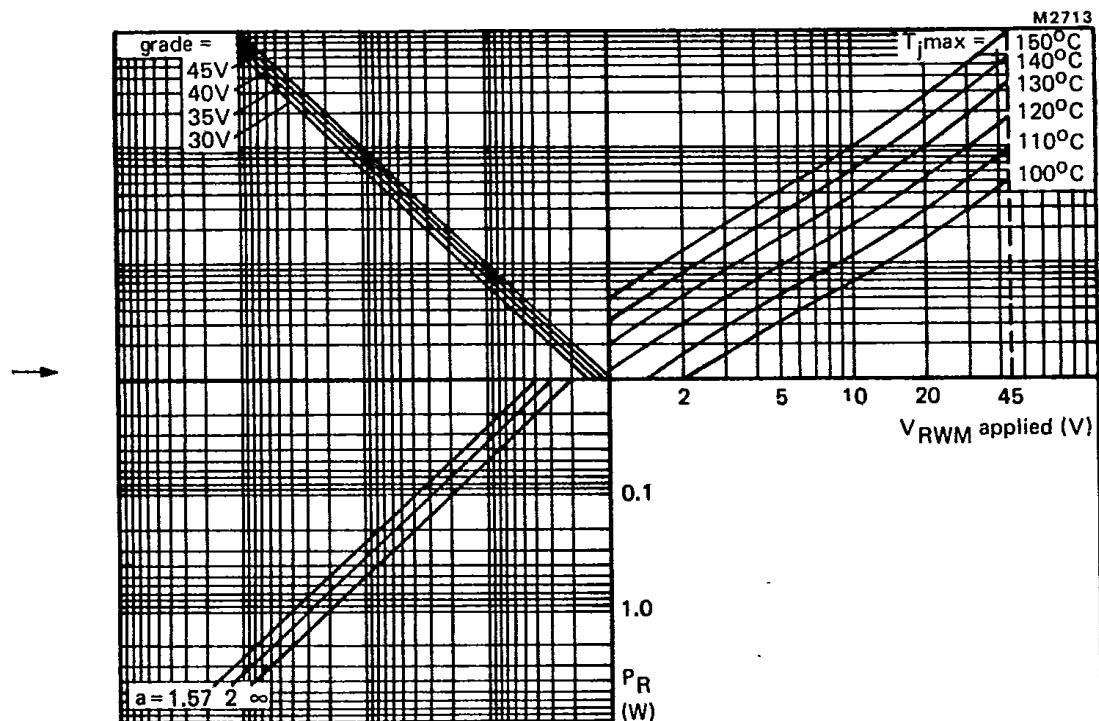


Fig.5 NOMOGRAM: for calculation of P_R (reverse leakage power dissipation)
for a given T_j max., V_{RWM} applied, voltage grade and form factor.
 a = form factor = $I_F(\text{RMS})/I_F(\text{AV})$.

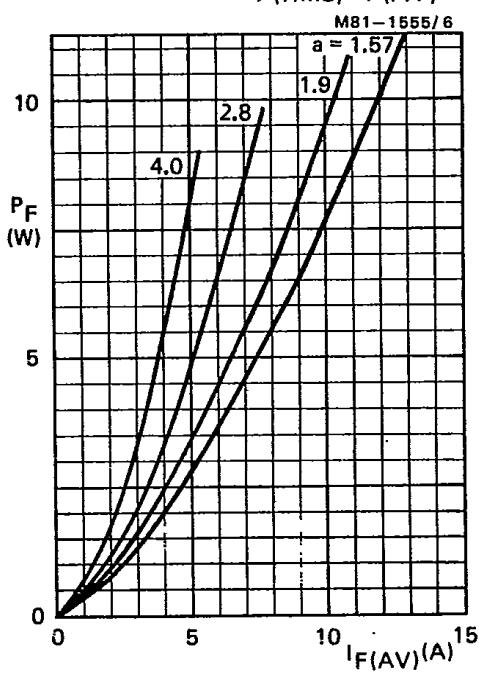


Fig.6.

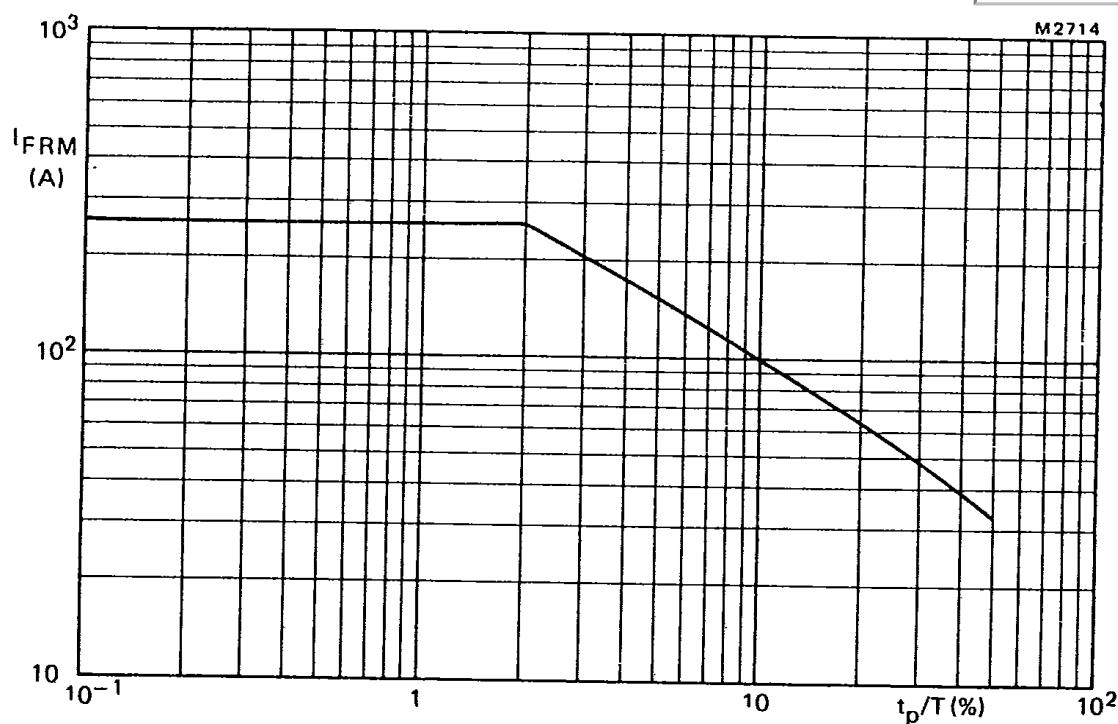
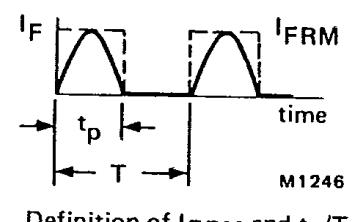
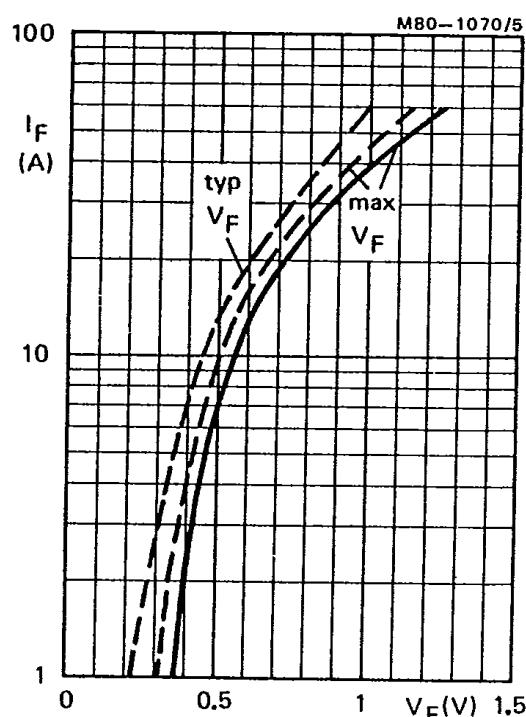


Fig.7 Maximum permissible repetitive peak forward current for either square or sinusoidal currents for $1 \mu\text{s} < t_p < 1 \text{ ms}$.



Definition of I_{FRM} and t_p/T .

Fig.8 — $T_j = 25^\circ\text{C}$; $-- T_j = 100^\circ\text{C}$.

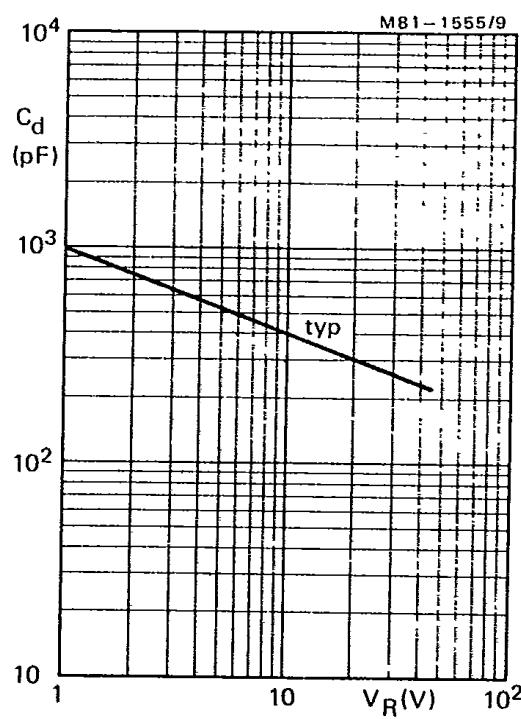
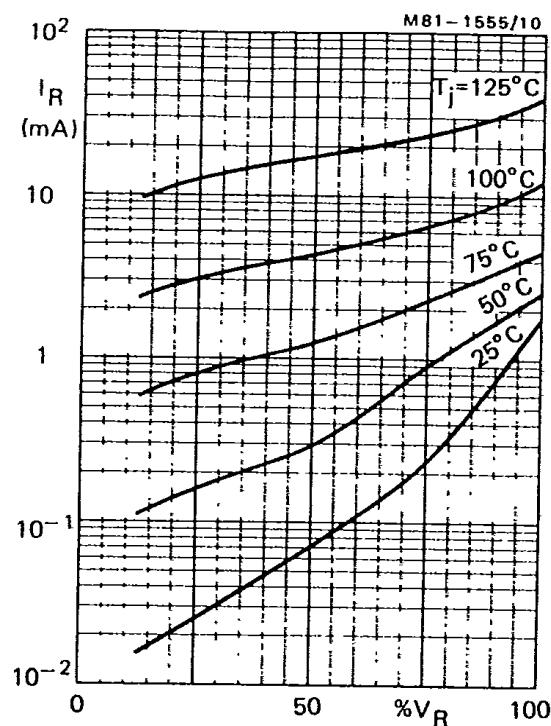
Fig.9 $f = 1$ MHz; $T_j = 25$ to 125 °C.

Fig.10 Typical values.

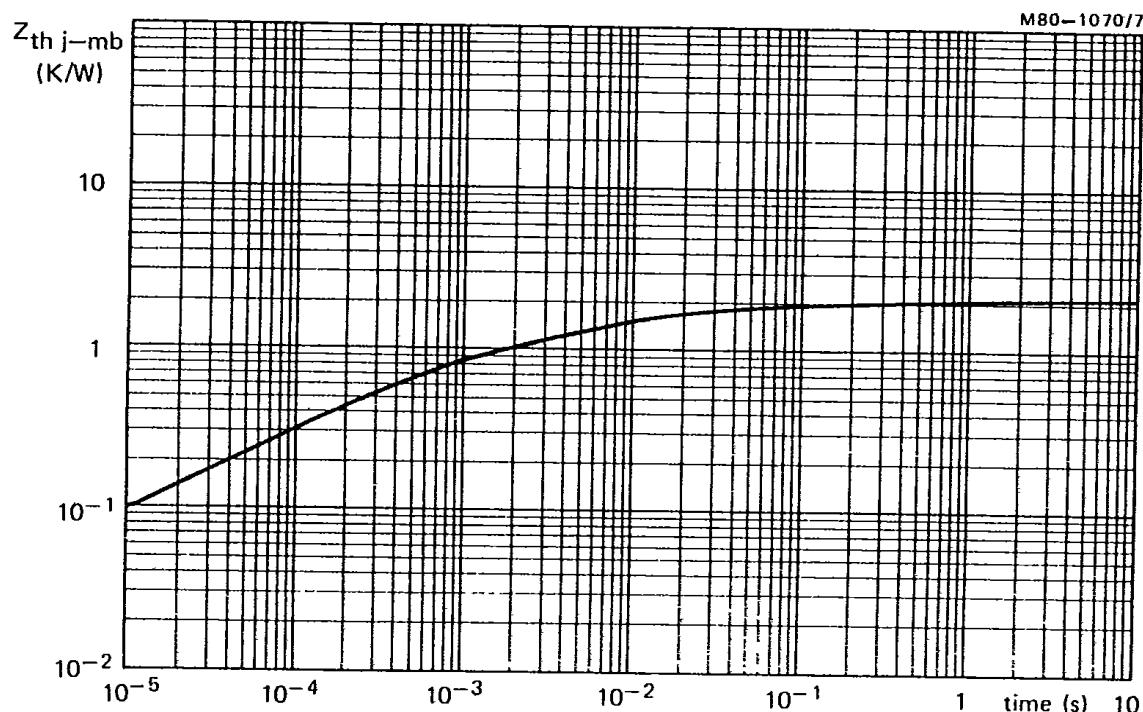


Fig.11 Transient thermal impedance.